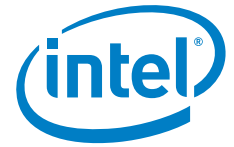




# Performance inside

2007 Annual Report

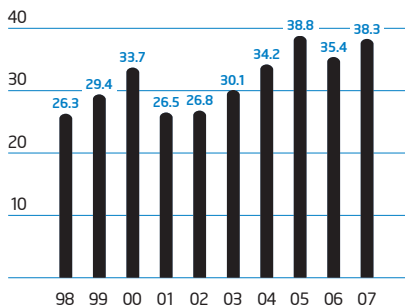
# Financial Results



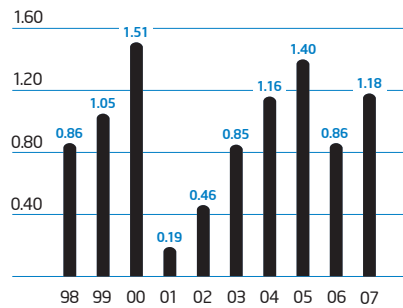
"2007 was a breakthrough year for innovation at Intel. We realized the benefits of our investments in new products and our ongoing efforts to drive efficiencies. We entered 2008 with the best combination of products, silicon technology, and manufacturing leadership in our history."

Paul S. Otellini, President and Chief Executive Officer

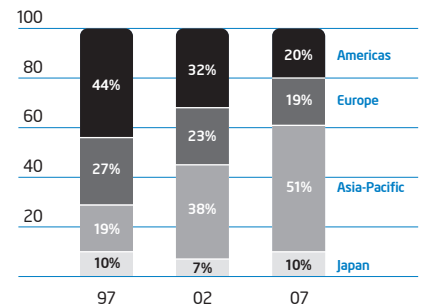
**Net Revenue**  
Dollars in billions



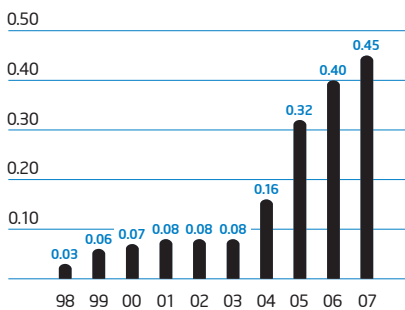
**Diluted Earnings Per Share**  
Dollars, adjusted for stock splits



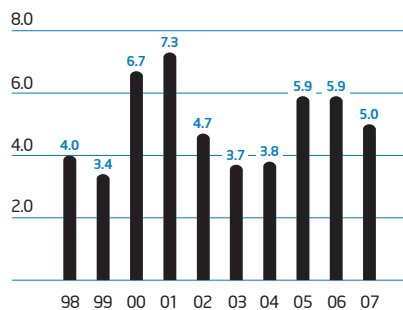
**Geographic Breakdown of Revenue**  
Percent



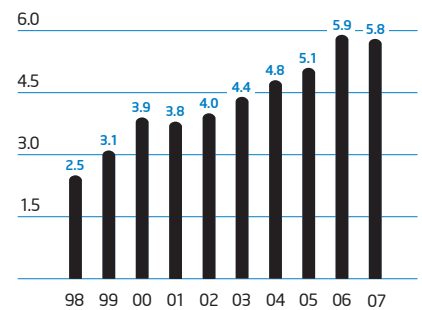
**Dividends Per Share Paid**  
Dollars, adjusted for stock splits



**Capital Additions to Property, Plant and Equipment**  
Dollars in billions



**Research and Development\*\***  
Dollars in billions



\*\*Excluding purchased in-process research and development

Financial results for 2006 and thereafter include the effects of share-based compensation. Financial results for years up to and including 2001 include the effects of goodwill amortization. Past performance does not guarantee future results. This Annual Report to Stockholders contains forward-looking statements, and actual results could differ materially. Risk factors that could cause actual results to differ are set forth in the "Risk Factors" section and throughout our 2007 Form 10-K, which is included in this Annual Report.



**On the cover:**  
**40 years of moving technology forward**

Since it was founded in 1968, Intel has been challenging the status quo. Each new generation of Intel processors offers higher performance, better energy efficiency, and more capabilities—unlocking new possibilities for people around the world. Shown left to right are five generations of Intel processors: 45nm Hi-k metal gate Intel® Core™2 processor (2007); Intel® Pentium® 4 processor (2000); Intel® Pentium® processor (1993); Intel386™ processor (1985); and 4004 microprocessor (1971).

# Letter From Your CEO



In 2007, we continued to focus on extending our product leadership; leveraging our world-class process technology and manufacturing capabilities; and creating a more efficient, customer-oriented Intel. Our fiscal year results reflect the significant progress we have made in all of these areas.

Revenue in 2007 was \$38.3 billion, up 8% over 2006. Our operating income was \$8.2 billion, up 45% over 2006. Net income for 2007 was \$7 billion, up 38% over 2006. Our cash dividend payout reached a record \$2.6 billion, and we announced a 13% increase in our cash dividend beginning in the first quarter of 2008.

## Renewed focus on core strengths

We have renewed our focus on leveraging two core strengths that distinguish Intel from the rest of our industry: the Intel® architecture and our unmatched ability to bring cutting-edge technologies to market year after year. As part of renewing our focus, we have divested several smaller operations—including those related to application processing, optical, and certain telecom products—and are contributing the assets of our NOR flash memory business to a newly formed independent company, Numonyx. At the same time, we are investing in new areas where we believe the application of highly integrated Intel architecture affords large growth opportunities, such as:

- Energy-efficient, low-cost mobile Internet devices and ultra-mobile PCs that enable people to communicate, enjoy digital media, and access the Internet wirelessly.
- New types of consumer electronics devices that combine entertainment functions with Internet connectivity.
- Scalable, high-performance visual computing solutions that integrate vivid graphics and supercomputing performance for scientific, financial services, and other compute-intensive applications.
- Low-cost PCs designed to meet the needs of first-time computer users, particularly in emerging markets.

## Advancing corporate responsibility

More and more, the global need for energy efficiency is affecting everything we do—from how we build and operate our facilities to how we design our products. We topped *Corporate Responsibility Officer* magazine's "10 Best Corporate Citizens by Industry 2007" list for technology hardware companies, and were the Technology Market Supersector Leader of the Dow Jones Sustainability Index for the seventh consecutive year. Such recognition acknowledges our global health and safety, community, and education programs, as well as our efforts to reduce our impact on the environment.

## Ground-breaking products and processes

We have established a roadmap for sustained technology leadership through our "tick-tock" strategy of introducing a new silicon process technology approximately every two years and ramping the next generation of microarchitecture in the intervening years.

Our 45-nanometer (nm) processors, launched in November 2007, were designed from the ground up with energy efficiency in mind. As of the end of February 2008, we offered more than 30 of these processors, which are built using Intel 45nm Hi-k metal gate silicon technology, an entirely new transistor composition that minimizes electrical leakage and enables us to continue the pace of innovation. They boast nearly twice the transistor density—up to 820 million transistors for quad-core processors—compared to previous chips built on our 65nm technology, and have set a number of records on key industry performance benchmarks, while consuming less power. These eco-friendly processors are also manufactured using a lead-free process.

We are on track to ship our new, highly innovative microarchitecture—code-named "Nehalem"—in 2008, extending our lead in both performance and power. We have also already demonstrated our 32nm process technology, scheduled for introduction in 2009.

## Strong demand for our products

Throughout 2007, we saw robust demand for our products across multiple business segments and geographies. In November 2006, we launched the industry's first quad-core processors, and by the end of 2007, we had shipped more than 6 million quad-core units. In 2007, we completed our transition to the Intel® Core™ microarchitecture, delivering its energy-efficient performance benefits across our entire desktop, mobile, and server processor lines.

Our integrated platforms—which combine Intel processors and other technologies to address specific user needs—continue to provide value that customers can't get elsewhere. Platform products such as those built with Intel® Centrino® processor technologies have enabled us to take advantage of the worldwide shift from desktop to mobility products, contributing to revenue growth in that segment of 19% year over year.

## Building on 40 years of innovation

We have also made significant progress on improving efficiency across all of our business operations. For example, during 2007 we achieved our goal to reduce the amount of time it takes to process wafers in our factories by 50%. We recognized savings of about two and a half billion dollars in 2007 and expect additional savings in 2008 as a result of our ongoing efficiency efforts. In addition, our 2007 customer survey results indicate significant improvements in our customer service and responsiveness.

I am extremely proud of our employees, and as we approach our 40th anniversary in July 2008, I have no doubt that they will continue to carry on Intel's unwavering commitment to moving technology forward and creating products that change people's lives.

A handwritten signature in black ink that reads "Paul S. Otellini". The signature is written in a cursive, flowing style.

Paul S. Otellini, President and Chief Executive Officer

## Letter From Your Chairman



Our competitive position is the strongest it has been in years. Demand for our industry-leading products and manufacturing technologies helped drive strong revenue and earnings growth in 2007, and our efforts to increase operational efficiencies resulted in substantial savings. We repurchased more than 111 million shares of stock, reported a record cash dividend payout, and announced a 13% increase in our cash dividend.

Despite these positive results and an approximate 32% increase in our stock price during 2007, we saw our stock price fall subsequent to year-end, due in part to market concerns about a slowdown in the U.S. economy and a potential slowing computer marketplace. We have an increasingly international business profile—with about 70% of our products going to non-U.S. markets—but our stock price continues to be closely coupled to the U.S. economic outlook.

Our strategy has been, and continues to be, to invest in new products, technologies, and business efficiencies regardless of the ups and downs of economic cycles. Currently, we are investing to further expand our business in emerging markets and to develop products for market segments that we believe offer growth opportunities, such as mobile Internet devices, consumer electronics, advanced graphics, and low-cost PCs.

Looking back on 2007, I am reminded of the profound effects that our industry has on people across the globe. Through the Intel World Ahead Program, we are seeing examples of these effects. This program integrates and extends our efforts to provide people in emerging markets with technology training and access to affordable, connected PCs to improve education, healthcare, and economic development. On a recent trip to Baramati, a village in western India, I saw how technology is changing communities. The schools have few computers, but the villagers' desire for technology is strong. Local authorities have turned school buses into traveling computer labs, bringing technology to different schools on various days. I asked a 10-year-old girl what her favorite subject was, and she responded, "Tuesday." She said Tuesday was the day the PC bus came to her school, and it was the highlight of her week.

We also collaborate with business and government organizations, such as the World Economic Forum and the United Nations, to help expand the positive impact that technology can have globally. Together, we are not only working to improve lives, but also sowing the seeds for our future business—a true win-win proposition.

I believe we are well-positioned to continue to lead our industry in both business and corporate responsibility. We entered 2008 with what I believe is the best combination of products, silicon technology, and manufacturing leadership in our history. Our investments should allow us to take advantage of new growth opportunities worldwide.

Craig R. Barrett, Chairman of the Board

## 2007 Highlights



Intel 45nm Hi-k metal gate silicon technology:  
**One of the "Best inventions of the year."**

*TIME Magazine*



### Core Strengths

We are investing in new product areas, such as mobile Internet devices and ultra-mobile PCs, that leverage two of our core strengths: Intel® architecture and our cutting-edge manufacturing technology.



### Platform Advantage

By combining Intel® processors and other technologies in platform products, we provide added value that customers can't get elsewhere, allowing us to take advantage of trends such as the worldwide shift to mobility.



### Technology Impact

Through the Intel World Ahead Program, we continue to demonstrate the impact that our technology can have on improving education, healthcare, economic development, and governance around the world.



### Energy Efficiency

The global need to reduce power usage contributed to strong demand throughout the year for our products based on the energy-efficient Intel® Core™ microarchitecture, including those for compute-intensive server applications.

# Corporate Directory\*\*

## BOARD OF DIRECTORS

**Craig R. Barrett**<sup>4</sup>  
Chairman of the Board

**Ambassador Charlene Barshefsky**<sup>5</sup>  
Senior International Partner  
Wilmer Cutler Pickering Hale and Dorr LLP

**Carol A. Bartz**<sup>1 5</sup>  
Executive Chairman  
AutoDesk, Inc.

**Susan L. Decker**<sup>3</sup>  
President  
Yahoo! Inc.

**D. James Guzy**<sup>1 5f</sup>  
Chairman  
SRC Computers, Inc.  
*A private corporation*

**Reed E. Hundt**<sup>2f 3</sup>  
Principal  
Charles Ross Partners, LLC  
*A private investor and advisory service*

**Paul S. Otellini**<sup>4</sup>  
President and  
Chief Executive Officer

**James D. Plummer**<sup>1 5</sup>  
John M. Fluke Professor  
of Electrical Engineering  
Frederick E. Terman Dean  
of the School of Engineering  
Stanford University

**David S. Pottruck**<sup>1 2 5</sup>  
Chairman and  
Chief Executive Officer  
Red Eagle Ventures, Inc.  
*A San Francisco private equity firm*

**Jane E. Shaw**<sup>1f 5</sup>  
Retired Chairman and  
Chief Executive Officer  
Aerogen, Inc.  
*A specialty pharmaceutical company*

**John L. Thornton**<sup>2 3</sup>  
Professor and  
Director of Global Leadership  
Tsinghua University (Beijing)

**David B. Yoffie**<sup>2 3f 4f 6</sup>  
Max and Doris Starr  
Professor of International  
Business Administration  
Harvard Business School

## CO-FOUNDER

**Gordon E. Moore**  
Co-Founder

## SENIOR ADVISOR

**Andrew S. Grove**  
Senior Advisor

<sup>1</sup> Member of Audit Committee

<sup>2</sup> Member of Compensation Committee

<sup>3</sup> Member of Corporate Governance and Nominating Committee

<sup>4</sup> Member of Executive Committee

<sup>5</sup> Member of Finance Committee

<sup>6</sup> Lead Independent Director

<sup>f</sup> Committee Chairman

## CORPORATE OFFICERS

**Craig R. Barrett**  
Chairman of the Board

**Paul S. Otellini**  
President and  
Chief Executive Officer

**Andy D. Bryant**  
Executive Vice President,  
Finance and Enterprise Services  
Chief Administrative Officer

**Sean M. Maloney**  
Executive Vice President  
General Manager,  
Sales and Marketing Group  
Chief Sales and Marketing Officer

**David Perlmutter**  
Executive Vice President  
General Manager,  
Mobility Group

**Arvind Sodhani**  
Executive Vice President  
President, Intel Capital

**Robert J. Baker**  
Senior Vice President  
General Manager,  
Technology and  
Manufacturing Group

**Anand Chandrasekher**  
Senior Vice President  
General Manager,  
Ultra Mobility Group

**Patrick P. Gelsinger**  
Senior Vice President  
General Manager,  
Digital Enterprise Group

**William M. Holt**  
Senior Vice President  
General Manager,  
Technology and  
Manufacturing Group

**Eric B. Kim**  
Senior Vice President  
General Manager,  
Digital Home Group

**Patricia Murray**  
Senior Vice President  
Director, Human Resources

**D. Bruce Sewell**  
Senior Vice President  
General Counsel

**Sohail U. Ahmed**  
Vice President  
Director, Logic Technology  
Development

**Louis J. Burns**  
Vice President  
General Manager,  
Digital Health Group

**Douglas F. Busch**  
Vice President  
Chief Technology Officer,  
Digital Health Group

**Robert B. Crooke**  
Vice President  
General Manager,  
Business Client Group

**Leslie S. Culbertson**  
Vice President  
Director, Finance

**Shmuel Eden**  
Vice President  
General Manager,  
Mobile Platforms Group

**Ron Friedman**  
Vice President  
General Manager,  
Mobility Microprocessor Group

**Ravi Jacob**  
Vice President  
Treasurer

**Renee J. James**  
Vice President  
General Manager,  
Software and Solutions Group

**Thomas M. Kilroy**  
Vice President  
General Manager,  
Digital Enterprise Group

**Brian M. Krzanich**  
Vice President  
General Manager,  
Manufacturing and Supply Chain

**Justin R. Rattner**  
Vice President  
Director,  
Corporate Technology Group  
Intel Chief Technology Officer

**Stacy J. Smith**  
Vice President  
Chief Financial Officer

**Stephen L. Smith**  
Vice President  
Director, Digital Enterprise Group  
Operations

**William A. Swope**  
Vice President  
General Manager,  
Corporate Affairs Group

**Richard G. A. Taylor**  
Vice President  
Director, Human Resources

**Cary I. Klafter**  
Corporate Secretary

## APPOINTED VICE PRESIDENTS

### Corporate Technology Group

**Joseph D. Schutz**  
Director,  
Microprocessor Technology Lab

**Abel Weinrib**  
Director,  
Corporate Technology Group

**Donald M. Whiteside**  
Director,  
Technical Policy and Standards

### Digital Enterprise Group

**John D. Barton**  
General Manager,  
Platform Validation Engineering

**Rani N. Borkar**  
Director,  
Enterprise Microprocessor Group

**Diane M. Bryant**  
General Manager,  
Server Platforms Group

**Gregory Bryant**  
General Manager,  
Digital Office Platform Division

**Daniel J. Casaletto**  
Director, Microprocessor  
Architecture and Planning

**Douglas L. Davis**  
General Manager, Embedded and  
Communications Group

**James A. Johnson**  
General Manager,  
Visual Computing Group

**Thomas R. Macdonald**  
General Manager,  
Platform Components Group

**Rory M. McInerney**  
Director,  
Enterprise Microprocessor Group

**Prasad L. Rampalli**  
Director,  
End-User Platform Integration

**Clemente J. Russo**  
Director,  
Boards Strategy

**Sunil R. Shenoy**  
General Manager,  
Enterprise Microprocessor Group

**Kirk B. Skaugen**  
General Manager,  
Server Platforms Group

**Ton Steenman**  
General Manager, Embedded and  
Communication Processor Division

### Digital Health Group

**Patricia N. Perry**  
General Manager, Healthcare  
Information Technology

### Digital Home Group

**Bradley D. Daniels**  
Director, Engineering

**Jeffrey P. McCrea**  
General Manager,  
Consumer PC Platform Group

## Finance and Enterprise Services

**James G. Campbell**  
Corporate Controller

**Ron G. Hurlé**  
General Manager,  
IT Operations and Services

**John N. Johnson**  
Chief Information Officer

**Christina S. Min**  
Controller,  
Sales and Marketing Group

**Nanci S. Palmintere**  
Director,  
Global Tax and Trade

**Corine Perez**  
Controller,  
Digital Enterprise Group

**Ogden M. Reid**  
Director,  
Human Resources Legal Services  
and Compensation and Benefits

**Dianne L. Rudolph**  
Program Manager,  
Structure and Efficiency

**Kevin Sellers**  
Director, Investor Relations

**Jacklyn A. Sturm**  
Controller, Technology and  
Manufacturing Group

**Janice F. Wilkins**  
Director, Internal Audit

### Intel Capital

**Angela Biever**  
Managing Director,  
Consumer Internet Sector

**Kevin M. Corbett**  
Managing Director,  
Media and Entertainment Sector

**Keith R. Larson**  
Managing Director,  
Manufacturing, Memory and  
Health Sector

**Curt J. Nichols**  
Managing Director,  
Digital Home Sector

**Sriram Viswanathan**  
Managing Director,  
Mobility Sector  
General Manager,  
WiMAX Program Office

## Legal and Corporate Affairs

**Anne B. Gundelfinger**  
Associate General Counsel  
Director, Global Public Policy

**Cary I. Klafter**  
Director, Corporate Legal

**Suzan A. Miller**  
Deputy General Counsel

**Steven R. Rodgers**  
Associate General Counsel  
Director, Litigation

### Mobility Group

**Gil G. Frostig**  
Director, Technology Capabilities  
and Operations

**Richard Malinowski**  
General Manager,  
Client Components Group

**W. Eric Mentzer**  
General Manager,  
Graphics Development Group

**Rama K. Shukla**  
Director, Mobile Platform  
Program Office

**Gadi Singer**  
Assistant General Manager,  
Ultra Mobility Group

**Shane D. Wall**  
Director,  
Ultra Mobility Business Planning,  
Architecture and Software

**Elenora Yoeli**  
CPU Design Manager,  
Ultra Mobility Group

### Sales and Marketing Group

**L. Wilton Agatstein, Jr.**  
General Manager, Emerging  
Markets Platform Group

**John A. Antone**  
Director,  
New Channels and Operations

**Paul Bergevin**  
General Manager,  
Global Communications Group

**Nancy J. Bhagat**  
Director, Integrated Marketing

# Corporate Directory *(continued)*

**(Sophia) Lee Fang Chew**  
General Manager, Strategic  
Planning and Engagements

**Deborah S. Conrad**  
Director, Team Apple

**Laura G. Crone**  
Director,  
Global Accounts – Sun  
Microsystems

**Tammy L. Cyphert**  
Director of Operations,  
Intel Americas, Inc.

**Steve Dallman**  
General Manager,  
Worldwide Reseller Channel  
Organization

**John E. Davies**  
General Manager,  
Intel World Ahead Program

**Gordon G. Graylish**  
Assistant General Manager,  
Europe, Middle East, Africa

**Gerald J. Greeve**  
Director,  
Intel World Ahead Program

**Donald J. MacDonald**  
General Manager,  
Global Marketing

**Christian Morales**  
General Manager,  
Europe, Middle East, Africa

**Stuart C. Pann**  
General Manager,  
Customer Fulfillment,  
Planning and Logistics

**Gregory R. Pearson**  
President, Intel Americas, Inc.

**Thomas A. Rampone**  
General Manager,  
Channel Platforms Group

**Arthur W. Roehm**  
Director,  
Global Accounts – Dell

**Navin Shenoy**  
General Manager, Asia-Pacific

**Robert P. Swinnen**  
Co-President, Intel K.K. (Japan)

**Xu (Ian) Yang**  
General Manager,  
Intel China Ltd.

**Kazumasa Yoshida**  
Co-President, Intel K.K. (Japan)

## **Software and Solutions Group**

**Ricardo J. Echevarria**  
General Manager,  
Enterprise Solution Sales

**Douglas W. Fisher**  
General Manager,  
Systems Software Division

**Elliot D. Garbus**  
General Manager,  
Developer Relations Division

**Jonathan Khazam**  
General Manager,  
Client Solutions Software Division

**David O'Meara**  
Managing Director, Havok

**Wen-Hann Wang**  
General Manager,  
Software and Solutions and  
Product Development, China

## **Technology and Manufacturing Group**

**Mostafa Aghazadeh**  
Director, Chandler Assembly  
Technology Development

**David A. Baglee**  
Co-Executive Officer,  
IM Flash Technologies LLC\*\*\*

**Peng Bai**  
Director, Derivative Logic  
Technology Development

**Nasser Bozorg-Grayeli**  
Director, Assembly and Test  
Technology Development

**Craig C. Brown**  
Director, Direct Materials

**Robert E. Bruck**  
General Manager, Technology  
Manufacturing Engineering

**Peter Charvat**  
Director, Portland Technology  
Development Patterning  
and Manufacturing

**Andrew A. Chien**  
Director, Intel Research

**Maxine Fassberg**  
General Manager, Intel Israel  
Fab 28 Plant Manager

**Steven R. Grant**  
General Manager,  
iA Custom Foundry

**Gulsher S. Grewal**  
Fab D1DR Plant Manager

**Timothy G. Hendry**  
Fab 11X Plant Manager

**Franklin B. Jones**  
General Manager,  
Customer Fulfillment,  
Planning and Logistics

**Jerry W. Knoben**  
General Manager,  
Systems Manufacturing

**Michael C. Mayberry**  
Director,  
Components Research

**Patricia A. McDonald**  
Fab 20 Plant Manager

**Kaizad R. Mistry**  
Director, Logic Technology  
Integration

**James R. OHara**  
General Manager,  
Ireland Operations  
Fab 10/14 Plant Manager

**Sanjay D. Panditji**  
Director,  
Systems Technologies

**Sunit Rikhi**  
Director,  
Advanced Design, Logic  
Technology Development

\*\*\*49% owned by Intel  
Corporation, 51% owned  
by Micron Technology, Inc.

**Babak Sabi**  
Director,  
Corporate Quality Network

**Neil R. Tunmore**  
Director, Corporate Services

**Joshua M. Walden**  
General Manager,  
Assembly and Test

**Randy L. Wilhelm**  
General Manager,  
NAND Products Group

**Chiang Yuan Yang**  
Director, Technology,  
Intel Mask Operation

**Siva K. Yerramilli**  
Director, Design and  
Technology Solutions

## **SENIOR FELLOWS**

### **Corporate Technology Group**

**Kevin C. Kahn**  
Director, Communications  
Technology Lab

**Justin R. Rattner**  
Director,  
Corporate Technology Group  
Intel Chief Technology Officer

### **Digital Enterprise Group**

**Peter D. MacWilliams**  
Staff Platform Architect

**Stephen S. Pawlowski**  
Chief Technology Officer,  
General Manager,  
Architecture and Planning

### **Software and Solutions Group**

**Bryant E. Bigbee**  
Director, Systems Software

### **Technology and Manufacturing Group**

**Mark T. Bohr**  
Director, Process Architecture  
and Integration

**Yan A. Borodovsky**  
Director, Advanced Lithography

**Robert S. Chau**  
Director, Transistor Research  
and Nanotechnology

**Richard L. Coulson**  
Director, I/O Architecture

**Eugene S. Meieran**  
Director, Manufacturing  
Strategic Support

**Ian A. Young**  
Director, Advanced Circuits  
and Technology Integration

## **FELLOWS**

### **Corporate Technology Group**

**Shekhar Y. Borkar**  
Director, Microprocessor  
Technology Lab

**Vivek K. De**  
Director,  
Circuit Technology Research

**James P. Held**  
Director, Tera-Scale  
Computing Research

**Stephen R. Mooney**  
Director, I/O Research

**Mario J. Paniccia**  
Director,  
Photonics Technology Lab

**Krishnamurthy Soumyanath**  
Director, Communications  
Circuits Laboratory

### **Digital Enterprise Group**

**Matthew J. Adiletta**  
Director, Communication  
Infrastructure and Architecture

**Ajay V. Bhatt**  
Chief I/O Architect,  
Architecture and Planning Group

**John H. Crawford**  
Director, Computer Architect

**Joel S. Emer**  
Director,  
Microarchitecture Research

**Tryggve Fossum**  
Director,  
Microarchitecture Development

**Glenn J. Hinton**  
Director, IA-32 Microarchitecture  
Development

**Rajesh Kumar**  
Director, Circuit and  
Low Power Technologies

**P. Geoffrey Lowney**  
Director, Compiler and  
Architecture Advanced  
Development

**Rajendra S. Yavatkar**  
Director, System-on-Chip  
Architecture

### **Digital Health Group**

**Eric Dishman**  
Director, Product Research  
and Innovation

### **Digital Home Group**

**C. Brendan S. Traw**  
Chief Technology Officer

### **Legal and Corporate Affairs**

**David B. Papworth**  
Director, Microprocessor  
Product Development

### **Mobility Group**

**Siavash M. Alamouti**  
Chief Technology Officer,  
Mobile Wireless Group

**Simcha Gochman**  
Director, Future Mobile  
CPU Architecture

**Thomas A. Piazza**  
Director,  
Graphics Architecture

**Shreekanth Thakkar**  
Director, Ultra Mobility Group  
Platform Architecture

**Ofri Wechsler**  
Director, Mobility  
Microprocessor Architecture

## **Software and Solutions Group**

**Boris A. Babayan**  
Director, Architecture

**Shivnandan D. Kaushik**  
Director, Systems Software

**David J. Kuck**  
Director, Parallel and  
Distributed Solutions

**Seckin Unlu**  
Director,  
Enterprise Performance

## **Technology and Manufacturing Group**

**Gregory E. Atwood**  
Director, Communication  
Technology Development

**Albert Fazio**  
Director, Memory  
Technology Development

**Paolo A. Gargini**  
Director,  
Technology Strategy

**Tahir Ghani**  
Director, Transistor  
Technology and Integration

**Knut S. Grimsrud**  
Director, Storage Architecture  
Development

**William J. Grundmann**  
Director, Computer-Aided  
Design Research

**Karl G. Kempf**  
Director,  
Decision Technologies

**Kelin J. Kuhn**  
Director,  
Logic Device Technology

**Shih-Wuu Lee**  
Director, Advanced Circuit  
Modeling and Simulation

**Jose A. Maiz**  
Director, Logic Technology  
Quality and Reliability

**Neal R. Mielke**  
Director, Reliability Methods

**Devadas D. Pillai**  
Director, Operational  
Decision Support Technology

**Valluri R. Rao**  
Director, Analytical and  
Microsystems Technologies

**George E. Sery**  
Director, Device Technology  
Optimization

**Swaminathan Sivakumar**  
Director, Lithography

**Gregory F. Taylor**  
Director, Mixed Signal  
Circuit Technology

**Clair Webb**  
Director, Circuit Technology

**Kevin X. Zhang**  
Director, Advanced Memory  
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# Investor Information

**Investor materials.** [www.intc.com](http://www.intc.com)—Intel's Investor Relations home page on the Internet contains background on our company and our products, financial information, frequently asked questions, and our online annual report, as well as other useful information. For investor information, including additional copies of our Annual Report/10-K, 10-Qs, or other financial literature, visit our web site at [www.intc.com](http://www.intc.com) or contact Computershare Investor Services, LLC by phone at (800) 298-0146 (U.S. and Canada) or (312) 360-5123 (worldwide), or by e-mail through Computershare's web site at [www.computershare.com/contactus](http://www.computershare.com/contactus); or call Intel at (408) 765-1480 (U.S.); (44) 1793 403 000 (Europe); (852) 2844 4555 (Hong Kong); (81) 298 47 8511 (Japan).

**Intel on NASDAQ.** Intel's common stock trades on The NASDAQ Global Select Market\* under the symbol INTC.

**Direct stock purchase plan.** Intel's Direct Stock Purchase Plan allows stockholders to reinvest dividends and purchase Intel common stock on a weekly basis. For more information, contact Intel's transfer agent, Computershare Investor Services, LLC, by phone at (800) 298-0146 (U.S. and Canada) or (312) 360-5123 (worldwide), or by e-mail through Computershare's web site at [www.computershare.com/contactus](http://www.computershare.com/contactus).

**Transfer agent and registrar.** Computershare Investor Services, LLC, 250 Royall Street, Mail Stop 1A, Canton, MA 02021 USA. Stockholders may call (800) 298-0146 (U.S. and Canada) or (312) 360-5123 (worldwide), or send e-mail through Computershare's web site at [www.computershare.com/contactus](http://www.computershare.com/contactus) with any questions regarding the transfer of ownership of Intel stock.

**Independent registered public accounting firm.** Ernst & Young LLP, San Jose, California, USA.

**Corporate responsibility.** Intel brings technology, vision, and hands-on commitment to advancing people's lives and sustaining the planet. Intel remains a recognized world leader in corporate responsibility. We seek continuous improvement in the way the company is governed internally for the benefit of our stockholders, employees, communities, and other stakeholders. Our Corporate Responsibility web site at [www.intel.com/go/responsibility](http://www.intel.com/go/responsibility) includes our latest Corporate Responsibility Report, which details our performance on a wide variety of environmental, health, and safety issues, including social and community programs as well as Intel's workplace. The web site also includes our Corporate Governance Guidelines and Code of Conduct.

Intel is a recognized leader in sustainability for the way we responsibly manage our operations and design environmentally friendly products. We believe that technology is fundamental to finding solutions to the world's environmental challenges. In 2007, we announced initiatives to: construct the industry's first 45nm LEED-certified "green fab" in Chandler, Arizona; manufacture our 45nm processors using a lead-free process; and partner with Google and others to launch the Climate Savers Computing Initiative. In addition, the U.S. Environmental Protection Agency recently recognized Intel as the largest purchaser of green power in the history of its Green Power Partnership program.

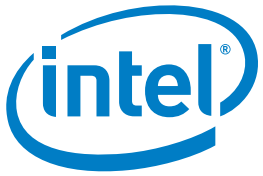
We strive to operate with uncompromising integrity and to be an asset to our communities. We believe that our business success depends on our ability to continue to be a trusted, responsible, open, and engaged corporate citizen. Community involvement is, and has been, a key part of Intel culture at every site at which we operate. More than one-third of our employees around the world contribute hundreds of thousands of volunteer hours each year to support local education and environmental programs, and build stronger communities through long-term relationships.

Through our education initiatives, we collaborate with educators and governments worldwide to advance 21st century education and prepare young people for success. Focused on improving teaching and learning through the effective use of technology and advancing math, science, and engineering education, Intel invests approximately \$100 million annually in programs in more than 50 countries. In 2007, Intel reached more than 1 million teachers through our Intel® Teach Program, and we launched the online version of the Intel Teach curriculum at the 2007 Clinton Global Initiative conference. Since its inception in 1998, Intel Teach has reached more than 5 million teachers in over 40 countries, and we plan to reach 8 million more by 2011. Complete information is available at [www.intel.com/education](http://www.intel.com/education).

The Intel World Ahead Program aims to enhance lives by accelerating access to uncompromised technology for everyone, everywhere. Focused on developing communities, the program integrates and extends our efforts to use technology to help people improve their lives. We are working with governments, development organizations, and community groups to advance progress in four main areas: accessibility, connectivity, education, and localized content. Our goal is to not only extend affordable access but also develop PCs tailored to local needs, drive critical connectivity, cultivate sustainable local capabilities, and provide the education needed to make a difference in people's lives. More information is available at [www.intel.com/intel/worldahead](http://www.intel.com/intel/worldahead).

In 2007, Intel received more than 50 awards and recognitions around the world for our work in the community, education, and overall corporate citizenship. Corporate Knights, Inc. again named Intel one of the 100 Most Sustainable Corporations in the World; Intel was the Technology Market Supersector Leader of the Dow Jones Sustainability Index for the seventh consecutive year and the only U.S.-based company named a Supersector leader; and Intel topped *Corporate Responsibility Officer* magazine's exclusive "10 Best Corporate Citizens by Industry 2007" list in the Technology Hardware category.

**The Intel® brand.** The Intel brand is consistently ranked as one of the most recognizable and valuable brands in the world. It represents our commitment to moving technology forward and is the embodiment of what we make possible for people everywhere. As the world leader in semiconductor technology, we relentlessly focus on industry leadership, innovation, and growth. Our microprocessors and innovative technologies help extend what technology can do for people.



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